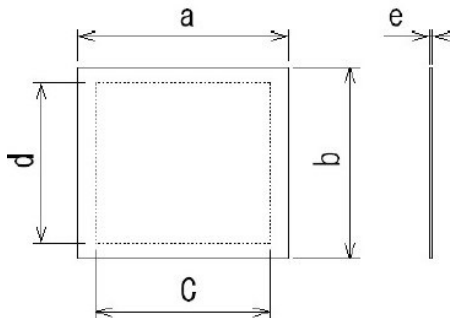
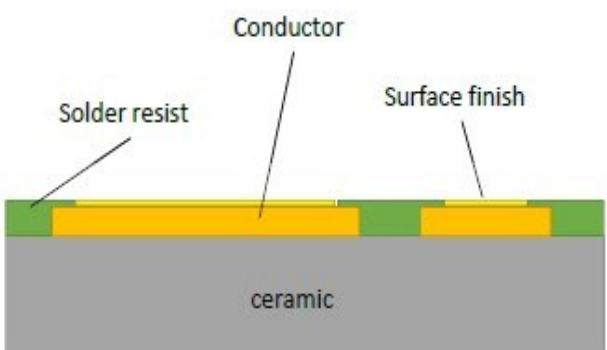
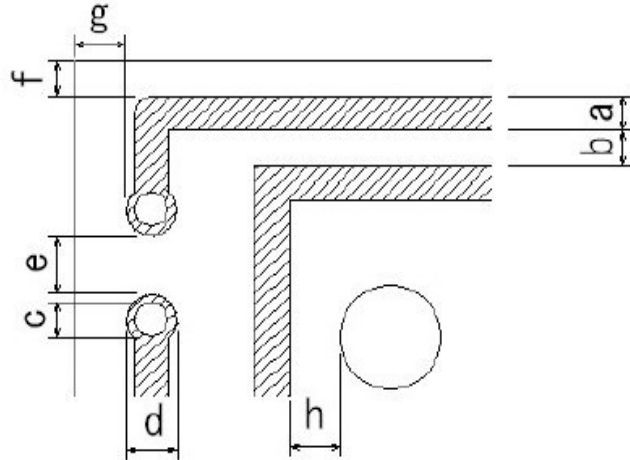


Ceramic Manufacturing Process – 96% Alumina Al ₂ O ₃ / Aluminium Nitride AlN Dimensions & Thicknesses		Manufacturing Guidelines	Rules & Guidelines	
	Panel Dimensions (a)x(b)			
	Standard Special	metric	115mm x 115mm Up to 170mm x 250mm	Working Area
	Standard Special	imperial	4.5" x 4.5" Up to 6.5" x 9.5"	
	Thickness (e)			Most Common / Widely Used
	Standard Special	metric	0,25/0.38/0.5/0.635/1.0/1.5mm Available upon request	
	Standard Special	imperial	10 / 15 / 20 / 25 / 39 / 59 mil Available upon request	
Metallisation & Finish				
	Conductor			
	Standard Special		Copper – Cu Available upon request	Most Common / Widely Used
	Standard Special	metric	35µm - 140µm 18µm / 175µm – 350µm	Most Common / Widely Used Frequent requirement for – possible via DBC
	Standard Special	imperial	1oz – 2oz 0.5oz / 5oz – 10oz	
	Surface Finish			Most Common / Widely Used
	Standard Special		Immersion Silver, ENGIG, ENEPIG EPIG (no nickel), please enquire	
	Solder Resist			Most Common / Widely Used EPIG – non-magnetic finish
	Standard Special		Green, Black, White, Transparent Other – please enquire	
	Silk Screen / Legend			
	Standard		Black, White	
Layers				
Standard		Single – double sided	Please enquire for Multilayer	

Ceramic Manufacturing Process – 96% Alumina Al₂O₃ / Aluminium Nitride AlN
Spacing & Vias

Manufacturing Guidelines

Rules & Guidelines



Min. Line Width (a)		
Standard	0.2mm / 8 mil	0.1mm accepted upon DFM approval
Special	0.1mm / 4 mil	
Min Line Width (b)		
Standard	0.2mm / 8 mil	0.1mm accepted upon DFM approval
Special	0.1mm / 4 mil	
Line / Pad to Edge Spacing (f)		
Standard	0.2mm / 8mil	
Via Specifications		
Via diameter (c)	0.08mm / 3 mil	Smallest possible hole / Via size.
Min. via spacing (b)	0.15mm / 6 mil	
Via/hole to edge spacing	3 x via diameter	E.g 1.0mm AlN required – divide by 5 = minimum Via diameter of 0.2mm
Min via diameter (c) (Aspect Ratio)	(Al ₂ O ₃ thickness/5)	
Through hole metallisation holes	Must be same weight as copper tracks	PTH only possible with DPC technology
Annular Ring Specifications		
Min. annular ring diameter (d)	Via diameter + 0.20mm / 8 mil	Minimum 0.10mm either side of via
Min. annular ring spacing (e)	0.20mm / 8 mil	
Annular ring to edge spacing (g)	0.20mm / 8 mil	
Line to Hole / via Spacing (h)		
Standard	0.2mm / 8 mil	0.1mm accepted upon DFM approval
Special	0.1mm / 4 mil	

Tolerance



Dimensional Tolerance		
Standard	+/- 100µm / 4 mil	
Thickness Tolerance		
Standard	+/- 10%	
Hole Tolerance		
Standard	+/- 100µm / 4 mil	
Pad to Hole / via Tolerance		
Standard	+/- 100µm / 4 mil	